

**USG10R044M****Power MOSFET****N-CHANNEL SGT
ENHANCEMENT POWER
MOSFET****DESCRIPTION**

The UTC **USG10R044M** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with high switching speed and low gate charge, etc.

The UTC **USG10R044M** applies to primary side switch, synchronous rectifier, Motor Drives, etc.

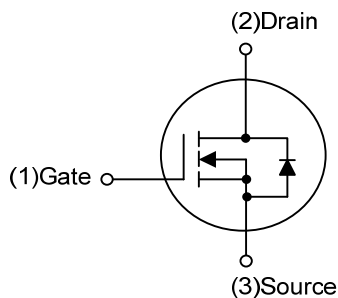
FEATURES

* $R_{DS(ON)} \leq 4.4 \text{ m}\Omega$ @ $V_{GS}=10\text{V}$, $I_D=30\text{A}$

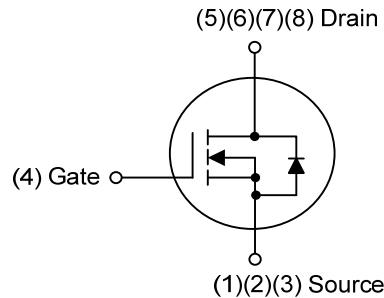
$R_{DS(ON)} \leq 5.9 \text{ m}\Omega$ @ $V_{GS}=4.5\text{V}$, $I_D=20\text{A}$

* High Cell Density Trench Technology

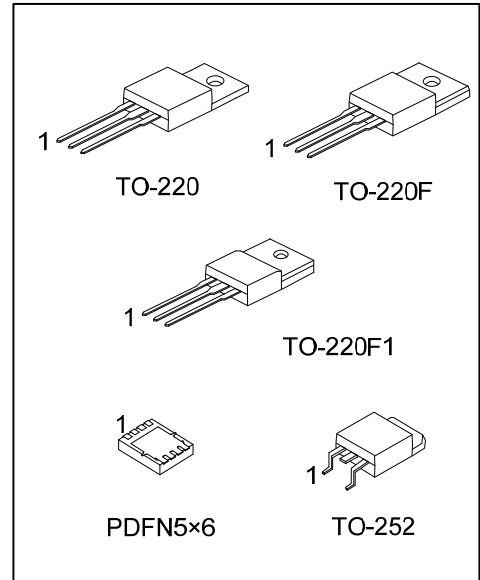
* High Power and Current Handling Capability

SYMBOL

TO-220 / TO-220F
TO-220F1 / TO-252



PDFN5x6

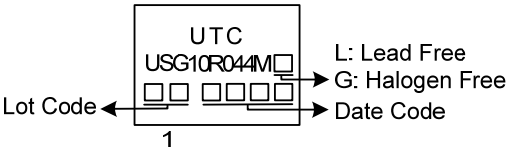
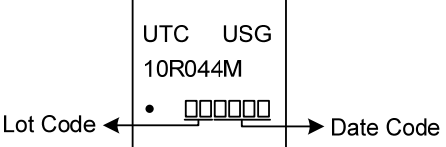
**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
USG10R044ML-TA3-T	USG10R044MG-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
USG10R044ML-TF1-T	USG10R044MG-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
USG10R044ML-TF3-T	USG10R044MG-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
USG10R044ML-TN3-R	USG10R044MG-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
USG10R044ML-P5060-R	USG10R044MG-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

USG10R044MG-TA3-T	(1)Packing Type	(1) T: Tube, R: Tape Reel
	(2)Package Type	(2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F
	(3)Green Package	TN3: TO-252, P5060: PDFN5x6
		(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING

TO-220 / TO-252	PDFN5×6
 UTC USG10R044M Lot Code ← 1 → Date Code L: Lead Free G: Halogen Free	 UTC USG 10R044M Lot Code ← • → Date Code

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	I _D	140	A
	Pulsed (Note 2)	I _{DM}	280	A
Single Pulsed Avalanche Energy (Note 3)		E _{AS}	55	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.3	V/ns
Power Dissipation	TO-220	P _D	135	W
	TO-220F/TO-220F1		44	W
	TO-252		65	W
	PDFN5×6		88	W
Junction Temperature		T _J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 0.1mH, I_{AS} = 33.2A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C

4. I_{SD} ≤ 30A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, T_J ≤ T_{JMAX}, T_J = 25°C.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	θ _{JA}	62.5	°C/W
	TO-220F1		110	°C/W
	TO-252		65 (Note)	°C/W
	PDFN5×6		65 (Note)	°C/W
Junction to Case (Note)	TO-220	θ _{JC}	0.92	°C/W
	TO-220F/TO-220F1		2.84	°C/W
	TO-252		1.92(Note)	°C/W
	PDFN5×6		1.42 (Note)	°C/W

Note: Device mounted on FR-4 substrate P_C board, 2oz copper, with 1inch square copper plate.

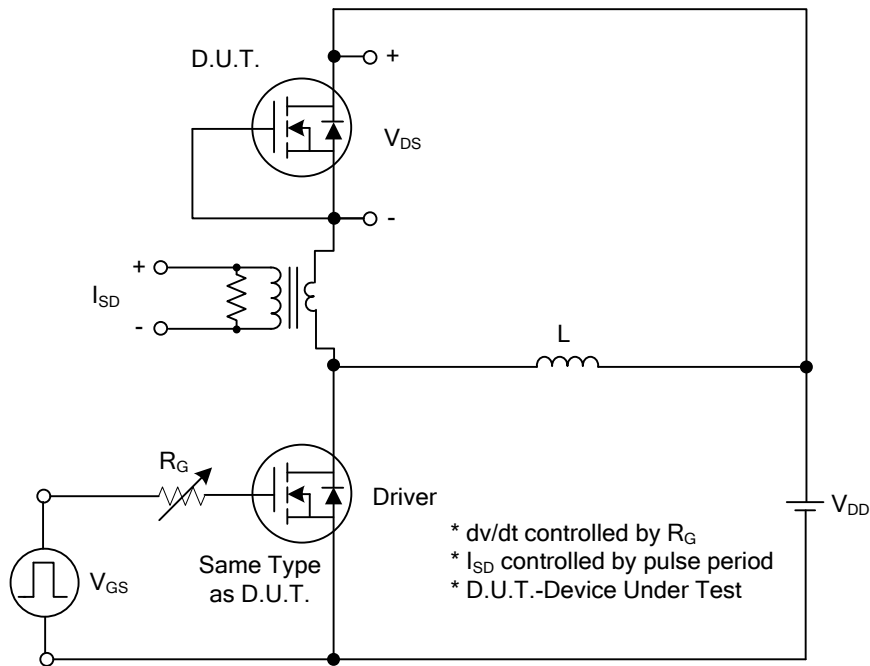
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	100			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	1.0		2.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =70A			4.4	mΩ
			V _{GS} =4.5V, I _D =70A			5.9	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		4643		pF
Output Capacitance		C _{OSS}			2120		pF
Reverse Transfer Capacitance		C _{RSS}			288		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q _G	V _{DS} =80V, V _{GS} =10V, I _D =70A		117		nC
Gate to Source Charge		Q _{GS}			12		nC
Gate to Drain Charge		Q _{GD}			49		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =50V, V _{GS} =10V, I _D =70A, R _G =3Ω		14		ns
Rise Time		t _R			22		ns
Turn-OFF Delay Time		t _{D(OFF)}			82		ns
Fall-Time		t _F			33		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				140	A
Maximum Body-Diode Pulsed Current		I _{SM}				280	A
Drain-Source Diode Forward Voltage		V _{SD}	I _F =30A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =30A, dI/dt=100A/μs		256		ns
Body Diode Reverse Recovery Charge		Q _{rr}			737		nC

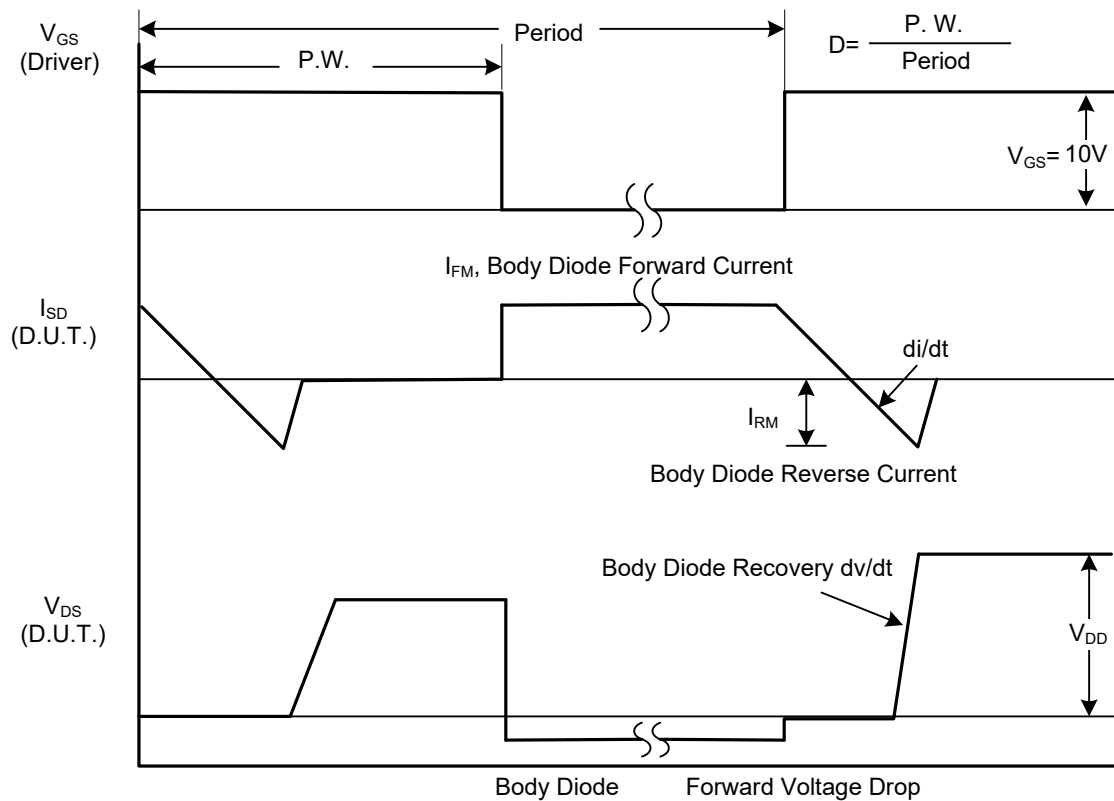
Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

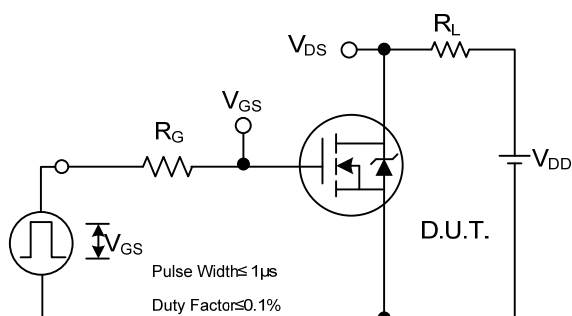


Peak Diode Recovery dv/dt Test Circuit

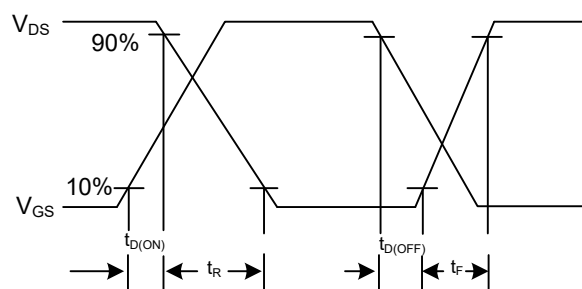


Peak Diode Recovery dv/dt Waveforms

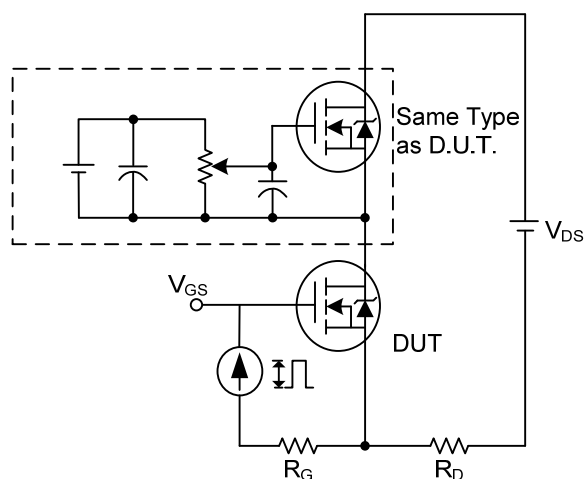
■ TEST CIRCUITS AND WAVEFORMS



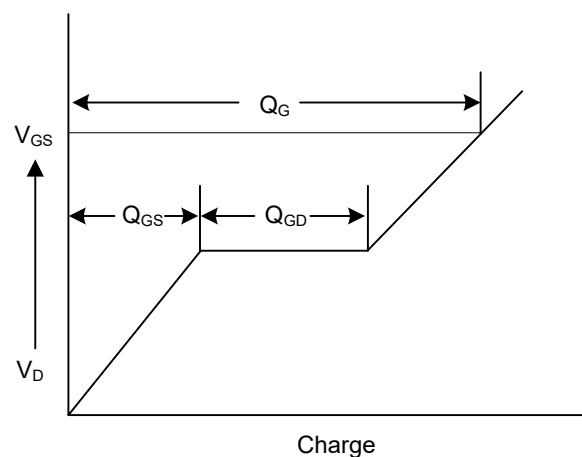
Switching Test Circuit



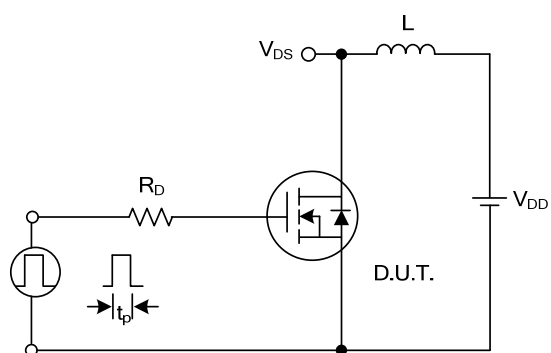
Switching Waveforms



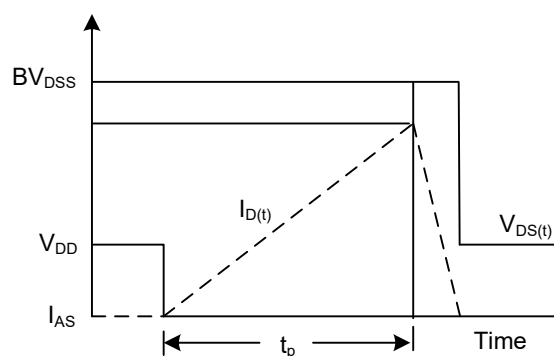
Gate Charge Test Circuit



Gate Charge Waveform

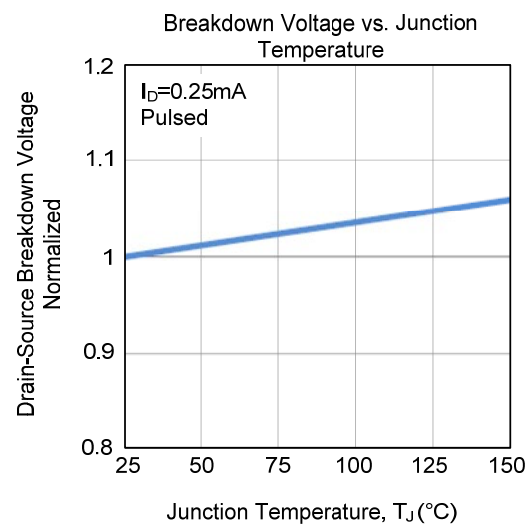
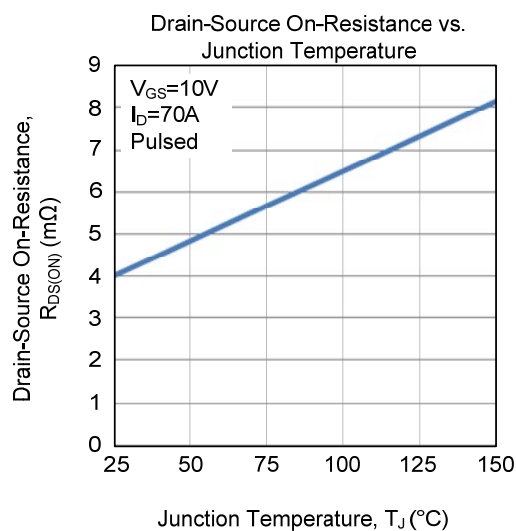
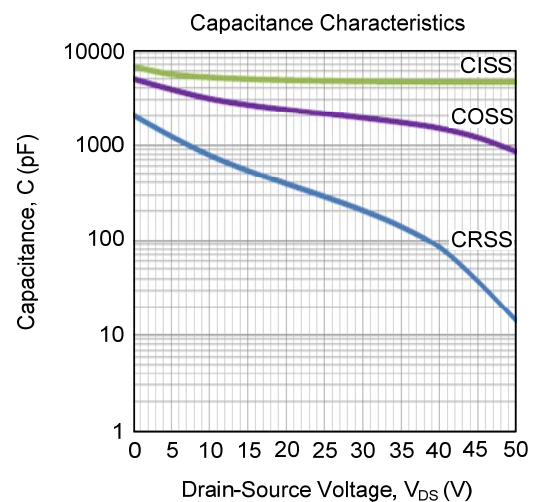
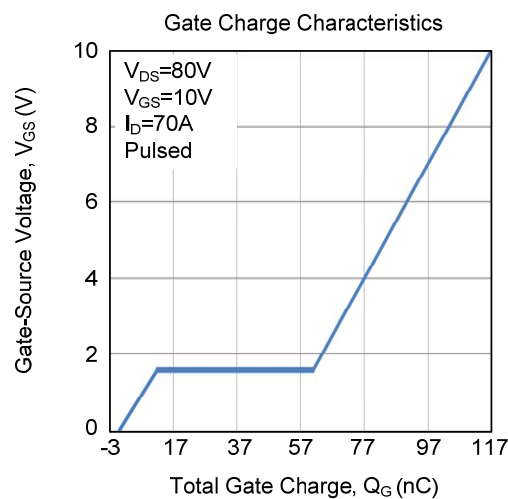
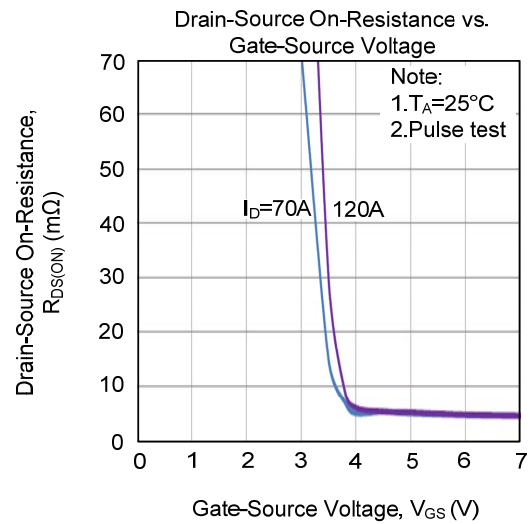
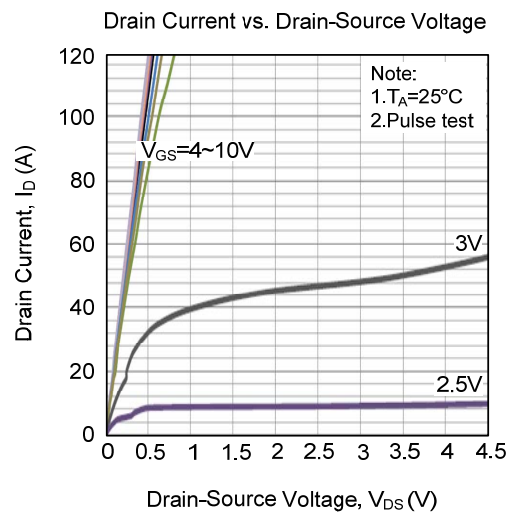


Unclamped Inductive Switching Test Circuit

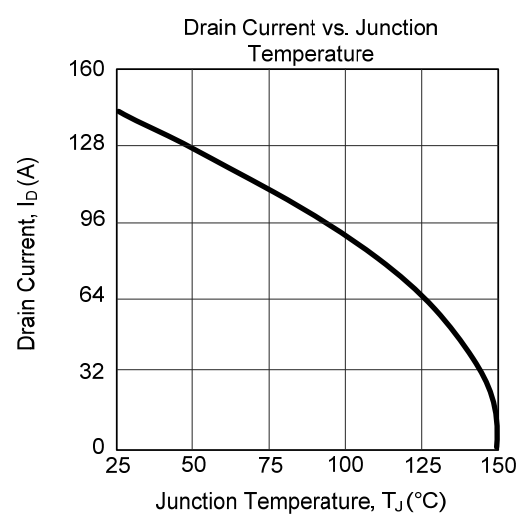
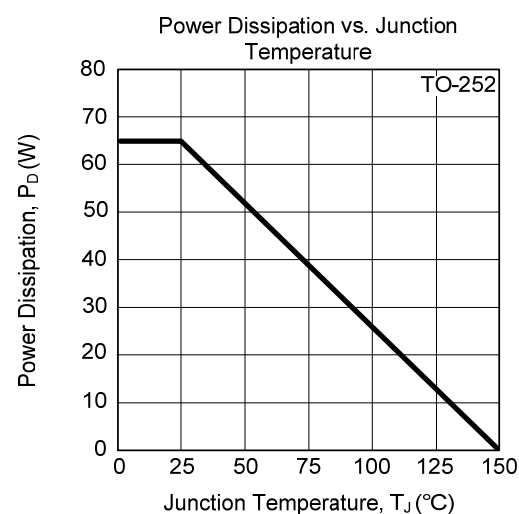
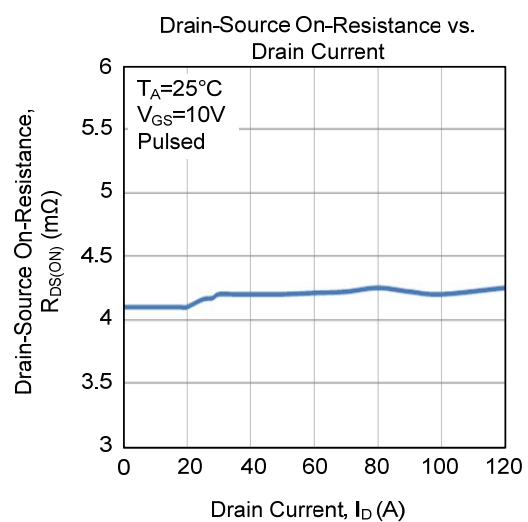
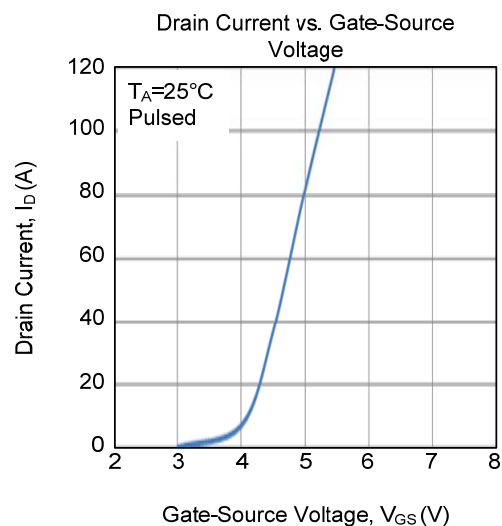
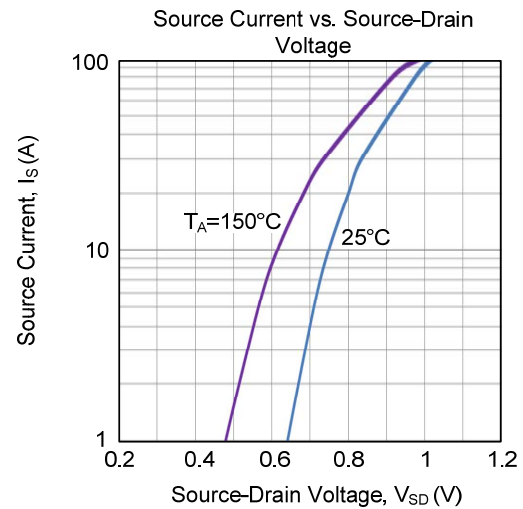
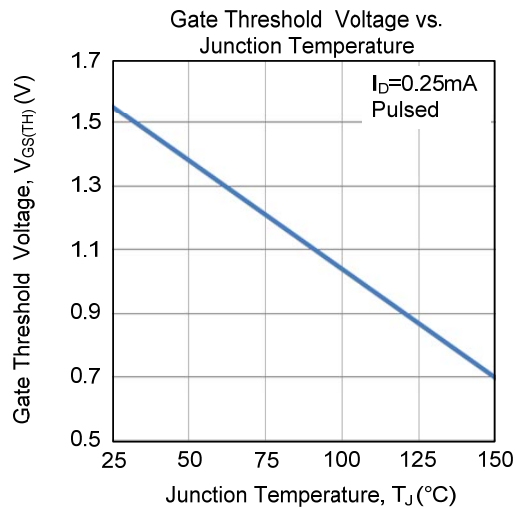


Unclamped Inductive Switching Waveforms

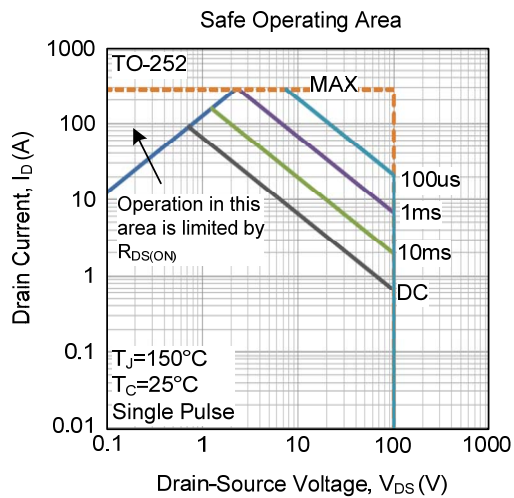
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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